

MA3V177 (MA177)

Silicon epitaxial planar type

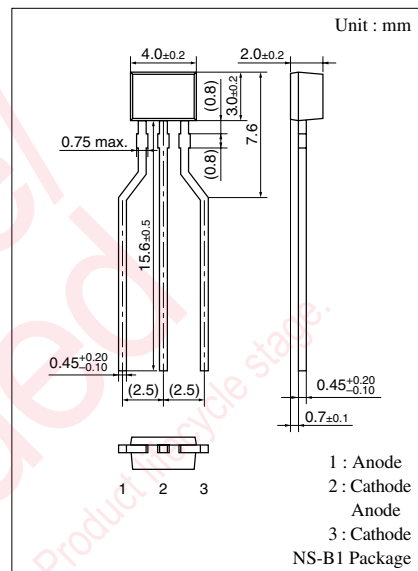
For switching circuits

■ Features

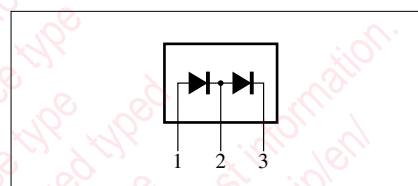
- Small terminal capacitance, C_t
- Can be connected in series

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

| Parameter | Symbol | Rating | Unit |
|----------------------|-----------|-------------|------------------|
| Reverse voltage (DC) | V_R | 40 | V |
| Peak reverse voltage | V_{RM} | 40 | V |
| Forward current (DC) | I_F | 100 | mA |
| Peak forward current | I_{FM} | 200 | mA |
| Junction temperature | T_j | 150 | $^\circ\text{C}$ |
| Storage temperature | T_{stg} | -55 to +150 | $^\circ\text{C}$ |



Internal Connection



■ Electrical Characteristics $T_a = 25^\circ\text{C}$

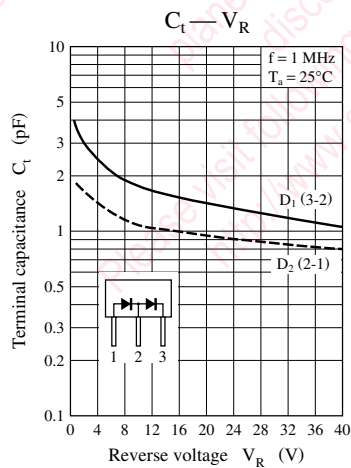
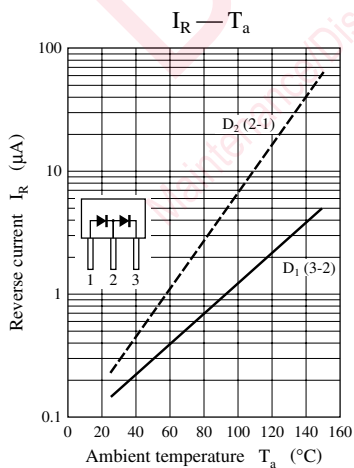
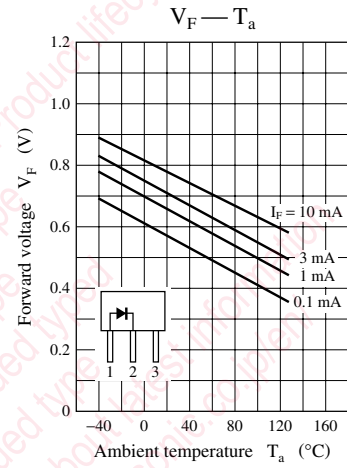
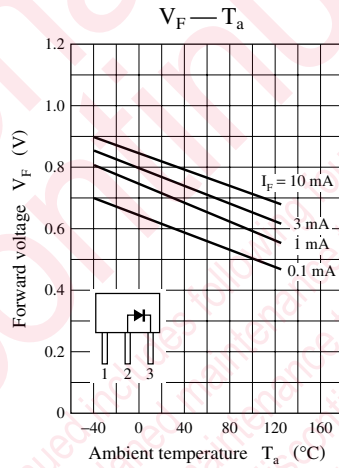
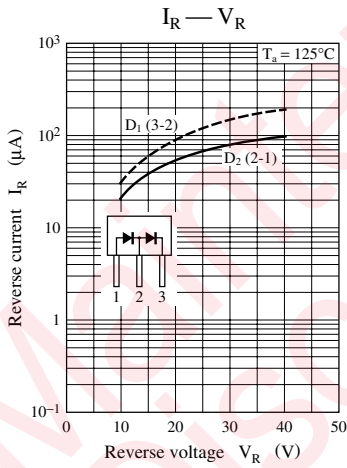
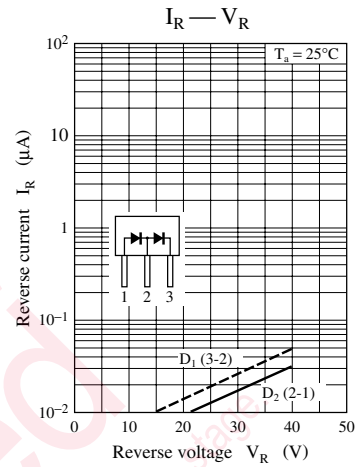
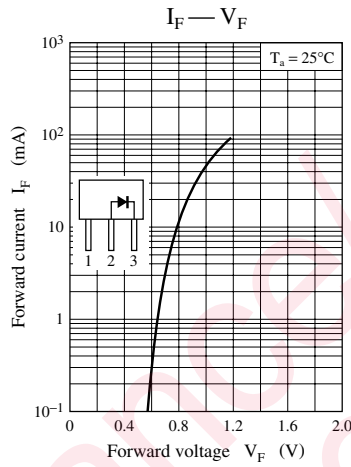
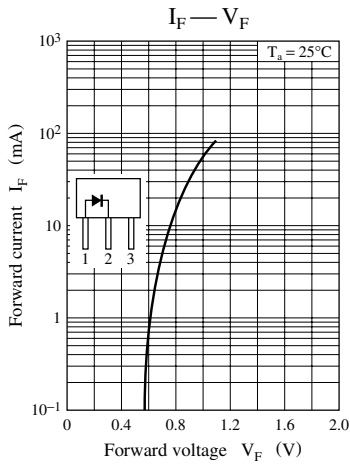
| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
|----------------------|---------------|--------------------------------------|-----|-----|-----|---------------|
| Reverse current (DC) | I_R | $V_R = 40\text{ V}$ | | | 0.1 | μA |
| Forward voltage (DC) | V_F | $I_F = 100\text{ mA}$ | | | 1.2 | V |
| Reverse voltage (DC) | V_R | $I_R = 100\ \mu\text{A}$ | 40 | | | V |
| Terminal capacitance | C_{t1}^{*1} | $V_R = 0\text{ V}, f = 1\text{ MHz}$ | | | 5.5 | pF |
| | C_{t2}^{*2} | | | | 3.0 | |

Note) 1. Rated input/output frequency: 100 MHz

2. *1 : Between pins 3 and 2

*2 : Between pins 2 and 1

Note) The part number in the parenthesis shows conventional part number.



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